



# **SPECIFICATION FOR RoHS 6 COMPLIANT HCMOS TCXO** MtronPTI P/N M6300S089

### **Electrical Specifications:**

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Frequency of Operation	Fo		100.000000		MHz	
Initial Accuracy		-1		+1	ppm	@ +25°C
			Frequency Sta	ability		
vs. Temperature	$\Delta F/F$			1.0	ppm	Over operating temp range (F <sub>Max</sub> - F <sub>Min</sub> )/2
		-3		+3	ppm	1 <sup>st</sup> year
vs. Aging		-2		+2		Thereafter (per year)
			RF Outpu	t		
Output Type			HCMOS			
Output Load			15		рF	
Symmetry (duty cycle)	T <sub>DC</sub>	45		55	%	1/2 VDD
Logic "1" Level	Vон	90% Vdd			V	HCMOS load
Logic "0" Level	V <sub>OL</sub>			10% V <sub>DD</sub>	V	HCMOS load
Rise/Fall Time	T <sub>R</sub> /T <sub>F</sub>			3	nS	From 10% to 90% V <sub>DD</sub>
			SSB Phase N	oise		
Typical Under Static Conditions			-64			@ 10Hz
			-97		dBc/Hz	@ 100Hz
			-121			@ 1kHz
			-129			@ 10kHz
			-135			@ 100kHz
			-143			@ 1 MHz
			-151			@ 10 MHz
			-153			@ 20 MHz
		Supply V	oltage & Powe	r Consump	otion	
Operating Voltage	Vcc	3.135	3.3	3.465	V	
Operating Current	Icc			90	mA	
	_		Temperature F	Range		
Operating Temperature	TA	-40		+85	°C	
Storage Temperature	TS	-55		+125	°C	

### **Environmental Conditions:**

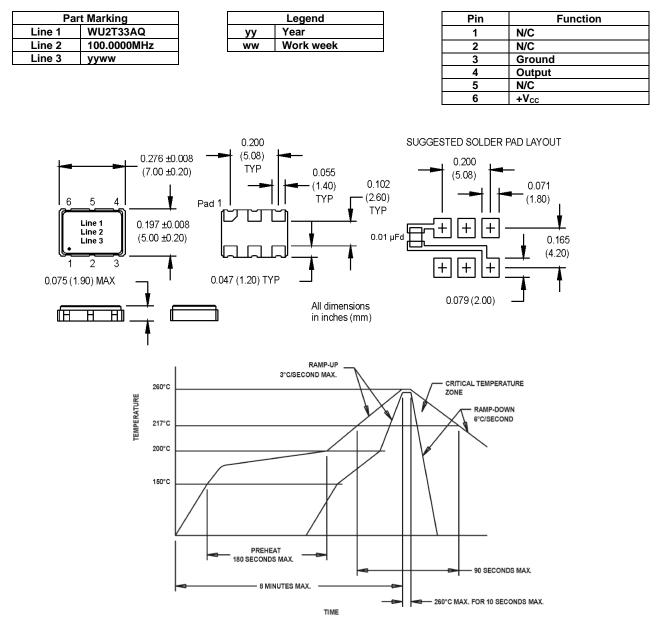
Shock	Per MIL-STD-202, Method 213, Condition C (100 g's, 6 ms duration, ½ sinewave)
Vibration	Per MIL-STD-202, Method 201 & 204 (10 g's from 10-2000 Hz)
Thermal Shock	Per MIL-STD-883, Method 1011, Condition A
Thermal Cycle	Per MIL-STD-883, Method 1010, Condition B
Hermeticity	Per MIL-STD-202, Method 112 (1 x 10 <sup>-8</sup> atm cc/s of helium)
Solderability	Per EIAJ-STD-002
Max. Soldering Conditions	See Figure 1.
Package Type	6-pad 5.0 X 7.0 X 1.9 mm leadless ceramic. RoHS compliant. M6300-Series





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### Mechanical, Marking, and Pin Out Information:





#### **Datasheet Revision Table:**

Date	Rev.	Author	Details of Revision
07/19/16	0	MM	Original release.